



Date:- 04 Oct, 2019

Data Sheet Issue:- P2

Tentative data

Insulated Gate Bi-Polar Transistor Type T1000EC33G

Absolute Maximum Ratings

	VOLTAGE RATINGS	MAXIMUM LIMITS	UNITS
V _{CES}	Collector – emitter voltage	3300	V
V _{DC link}	Permanent DC voltage for 100 FIT failure rate.	1800	V
V _{GES}	Peak gate – emitter voltage	±20	V

	RATINGS	MAXIMUM LIMITS	UNITS
I _{C(DC)}	DC collector current, IGBT	1000	A
I _{CRM}	Repetitive peak collector current, t _p =1ms, IGBT	2000	A
I _{F(DC)}	Continuous DC forward current, Diode	1000	A
I _{FRM}	Repetitive peak forward current, t _p =1ms, Diode	2000	A
I _{FSM}	Peak non-repetitive surge t _p =10ms, V _{RM} =60%V _{RRM} , Diode (Note 4)	6000	A
I _{FSM2}	Peak non-repetitive surge t _p =10ms, V _{RM} ≤10V, Diode (Note 4)	6600	A
P _{MAX}	Maximum power dissipation, IGBT (Note 2)	6.4	kW
P _D	Maximum power dissipation, Diode (Note 2)	4.05	kW
(di/dt) _{cr}	Critical diode di/dt (note 3)	2000	A/μs
T _j	Operating temperature range.	-40 to +125	°C
T _{stg}	Storage temperature range.	-40 to +125	°C

Notes: -

- 1) Unless otherwise indicated T_j = 125°C.
- 2) T_{sink} = 25°C, double side cooled.
- 3) Maximum commutation loop inductance 200nH.
- 4) Half-sinewave, 125°C T_j initial.

Characteristics

IGBT Characteristics

	PARAMETER	MIN	TYP	MAX	TEST CONDITIONS	UNITS	
V _{CE(sat)}	Collector – emitter saturation voltage	-	2.57	2.97	I _C = 1000A, V _{GE} = 15V, T _j = 25°C	V	
		-	3.40	3.80	I _C = 1000A, V _{GE} = 15V	V	
V ₀	Threshold voltage	-	-	1.84	Current range: 333 – 1000A	V	
r _s	Slope resistance	-	-	1.97		mΩ	
V _{GE(TH)}	Gate threshold voltage	-	5.3	-	V _{CE} = V _{GE} , I _C = 85mA	V	
I _{CES}	Collector – emitter cut-off current	-	10	25	V _{CE} = V _{CES} , V _{GE} = 0V	mA	
I _{GES}	Gate leakage current	-	-	±10	V _{GE} = ±20V	μA	
C _{ies}	Input capacitance	-	135	-	V _{CE} = 25V, V _{GE} = 0V, f = 1MHz	nF	
t _{d(on)}	Turn-on delay time	-	1.7	-	I _C = 1000A, V _{CE} = 1800V, di/dt = 2000A/μs V _{GE} = ±15V, L _S = 200nH R _{G(ON)} = 2.2Ω, R _{G(OFF)} = 15Ω, C _{GE} = 430nF Integral diode used as freewheel diode (Note 3, 4 & 5)	μs	
t _{r(V)}	Rise time	-	1.8	-		μs	
Q _{g(on)}	Turn-on gate charge	-	21	-		μC	
E _{on}	Turn-on energy	-	2.6	-		J	
t _{d(off)}	Turn-off delay time	-	5.3	-		μs	
t _{f(I)}	Fall time	-	1.5	-		μs	
Q _{g(off)}	Turn-off gate charge	-	13	-		μC	
E _{off}	Turn-off energy	-	2.7	-		J	
I _{SC}	Short circuit current	-	3000	-		V _{GE} = +15V, V _{CC} = 1800V, V _{CEmax} ≤ V _{CES} , t _p ≤ 10μs	A

Diode Characteristics

	PARAMETER	MIN	TYP	MAX	TEST CONDITIONS	UNITS
V _F	Forward voltage	-	2.66	2.95	I _F = 1000A, T _j = 25°C	V
		-	3.0	3.3	I _F = 1000A	V
V ₀	Threshold voltage	-	-	1.71	Current range 333 - 1000A	V
r _s	Slope resistance	-	-	1.59		mΩ
I _{rm}	Peak reverse recovery current	-	470	-	I _F = 1000A, V _{GE} = ±15V, di/dt = 2000A/μs	A
Q _{rr}	Recovered charge	-	1040	-		μC
t _{rr}	Reverse recovery time, 50% chord	-	1.7	-		μs
E _r	Reverse recovery energy	-	1.2	-		J

Thermal Characteristics

	PARAMETER	MIN	TYP	MAX	TEST CONDITIONS	UNITS
R _{thJK}	Thermal resistance junction to sink, IGBT	-	-	15.6	Double side cooled	K/kW
		-	-	25.4	Collector side cooled	K/kW
		-	-	40.5	Emitter side cooled	K/kW
R _{thJK}	Thermal resistance junction to sink, Diode	-	-	24.7	Double side cooled	K/kW
		-	-	37.9	Cathode side cooled	K/kW
		-	-	70.8	Anode side cooled	K/kW
F	Mounting force	25	-	35	Note 2	kN
W _t	Weight	-	1.2	-		kg

Notes:-

- 1) Unless otherwise indicated T_j = 125°C.
- 2) Consult application note 2008AN01 for detailed mounting requirements
- 3) C_{GE} is additional gate – emitter capacitance added to output of gate drive
- 4) E_{on} integration time 15μs from 10% rising I_C.
- 5) E_{off} integration time 15μs from 90% falling V_{GE}.

Curves

Figure 1 – Typical collector-emitter saturation voltage characteristics

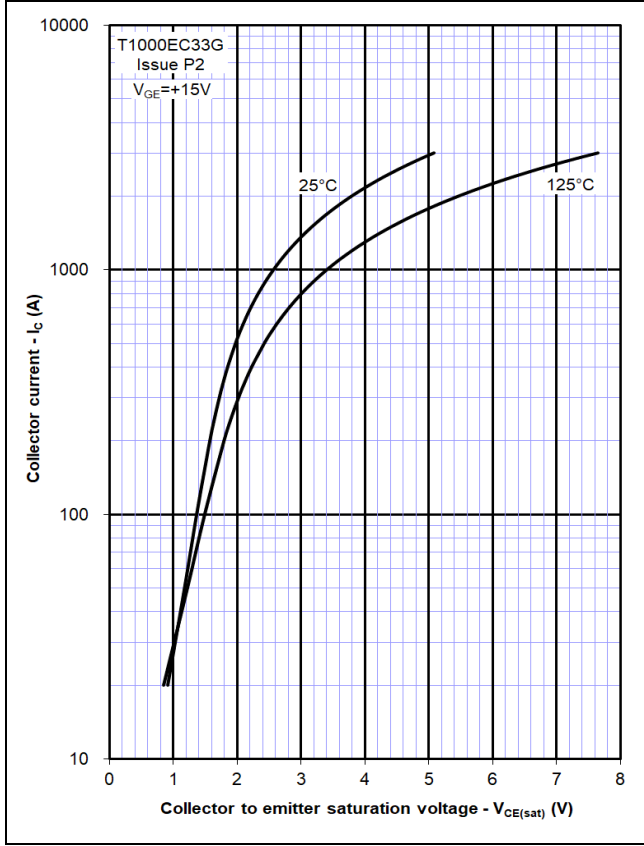


Figure 2 – Typical output characteristic

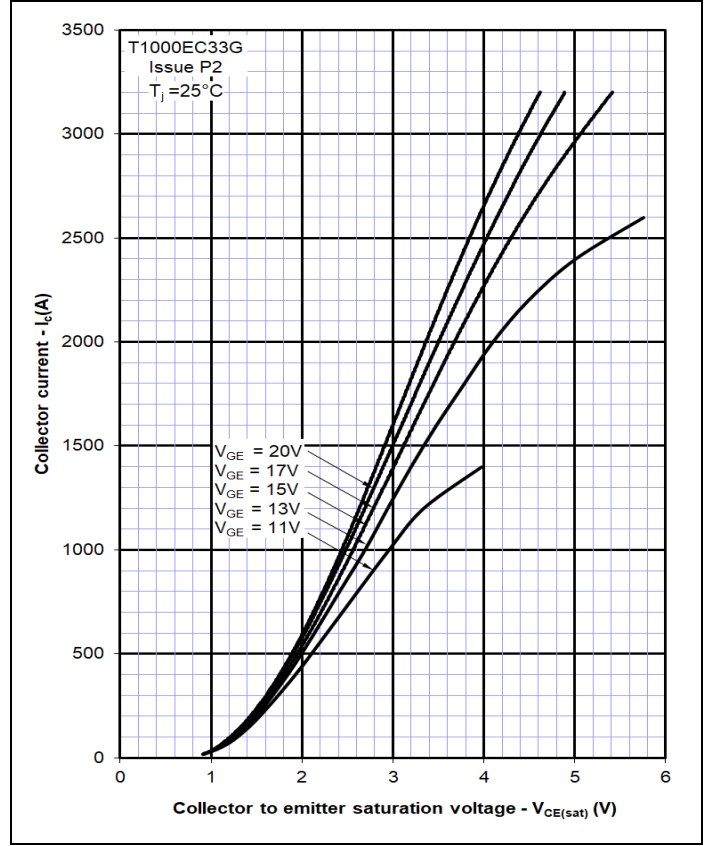


Figure 3 – Typical output characteristic

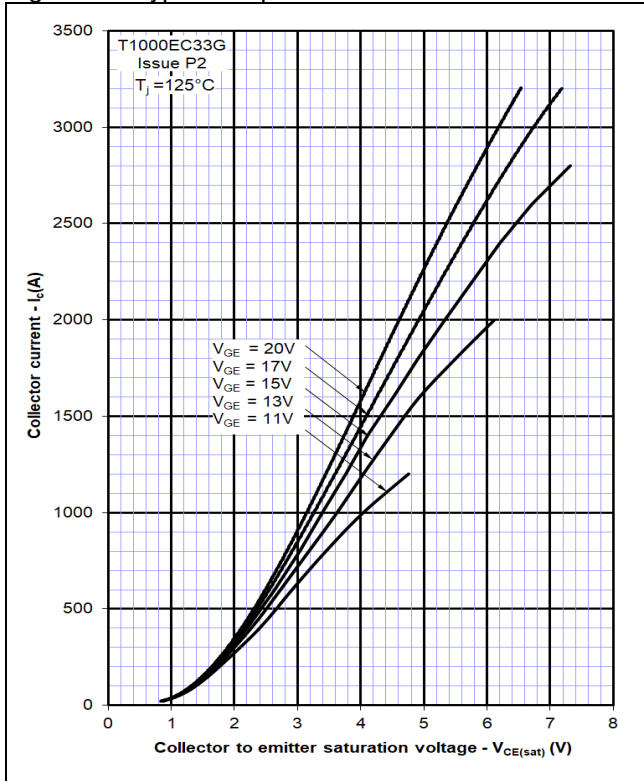


Figure 4 – Typical turn-on delay time vs gate resistance

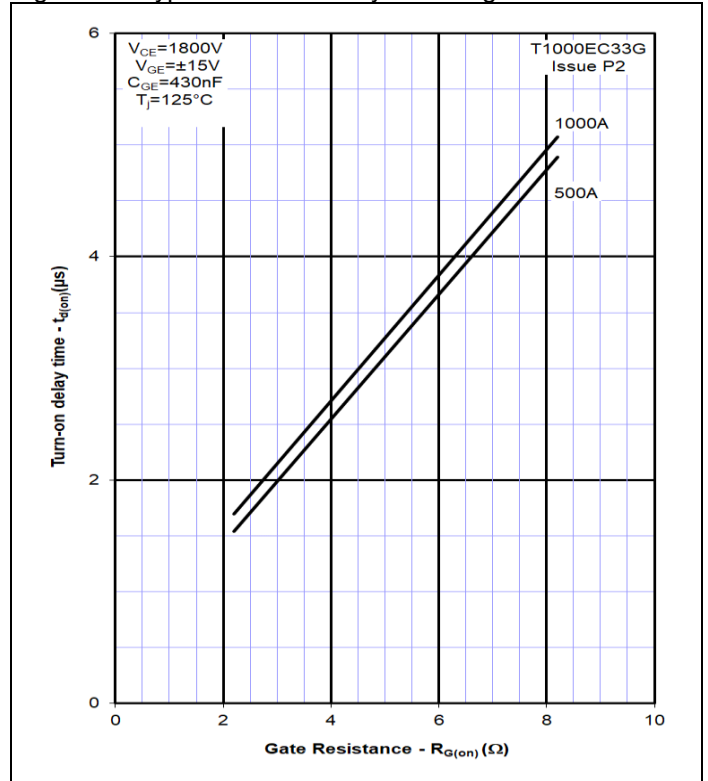


Figure 5 – Typical turn-off delay time vs. gate resistance

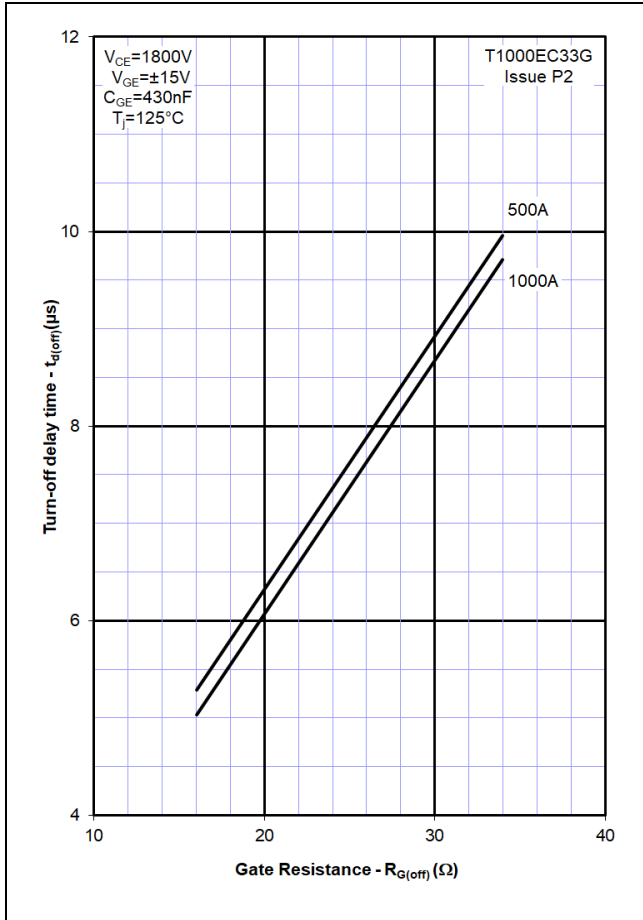


Figure 6 – Typical turn-on energy vs. collector current

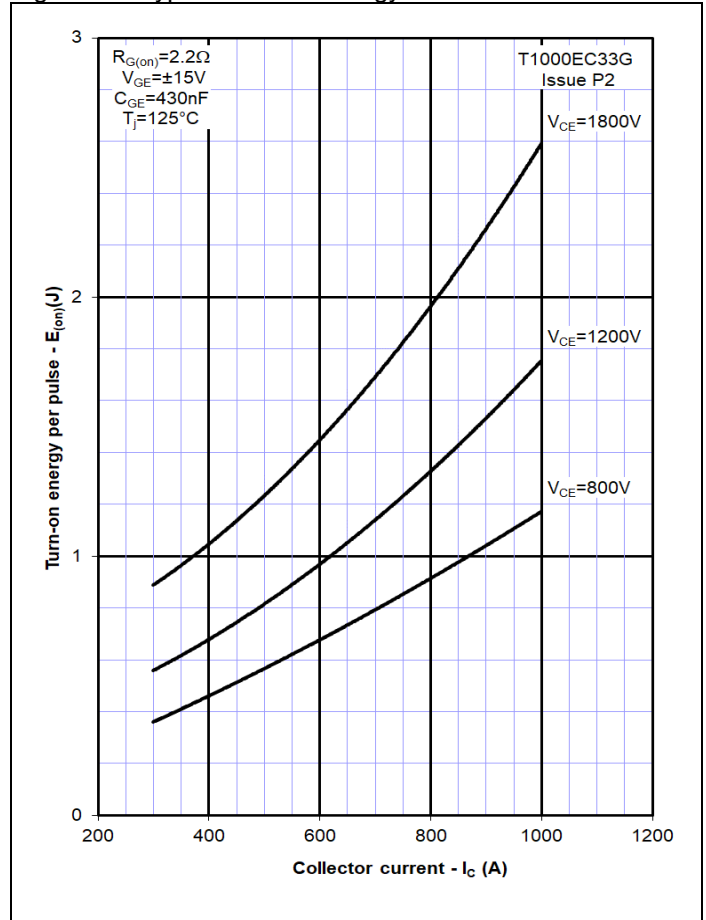


Figure 7 – Typical turn-on energy vs. di/dt

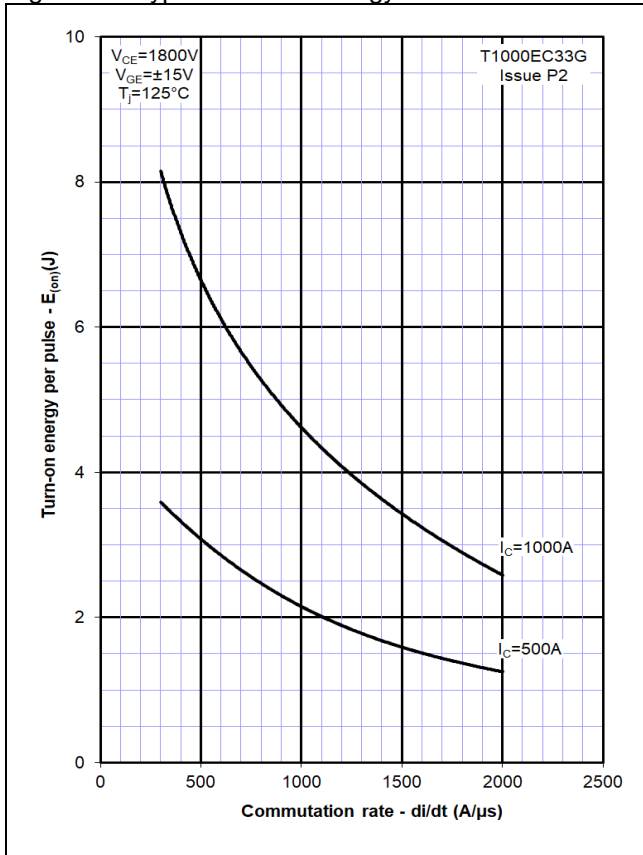


Figure 8 – Typical turn-off energy vs. collector current

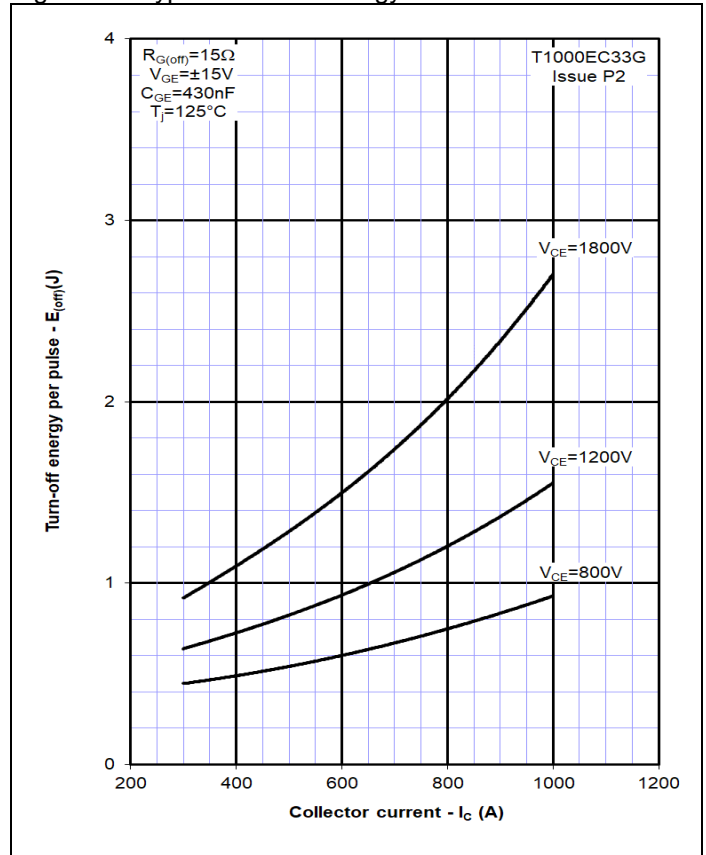


Figure 9 – Turn-off energy vs voltage

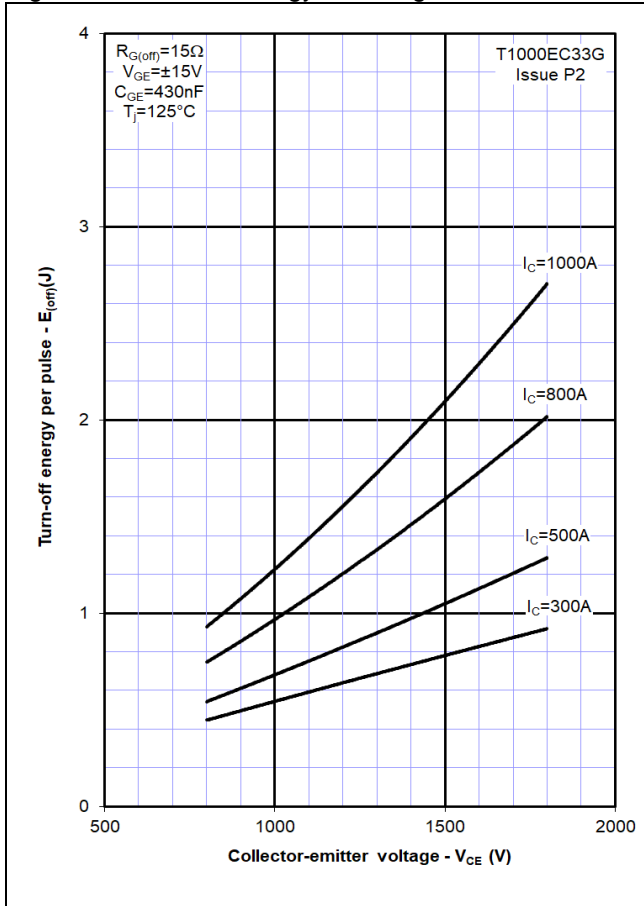


Figure 10 – Safe operating area (IGBT)

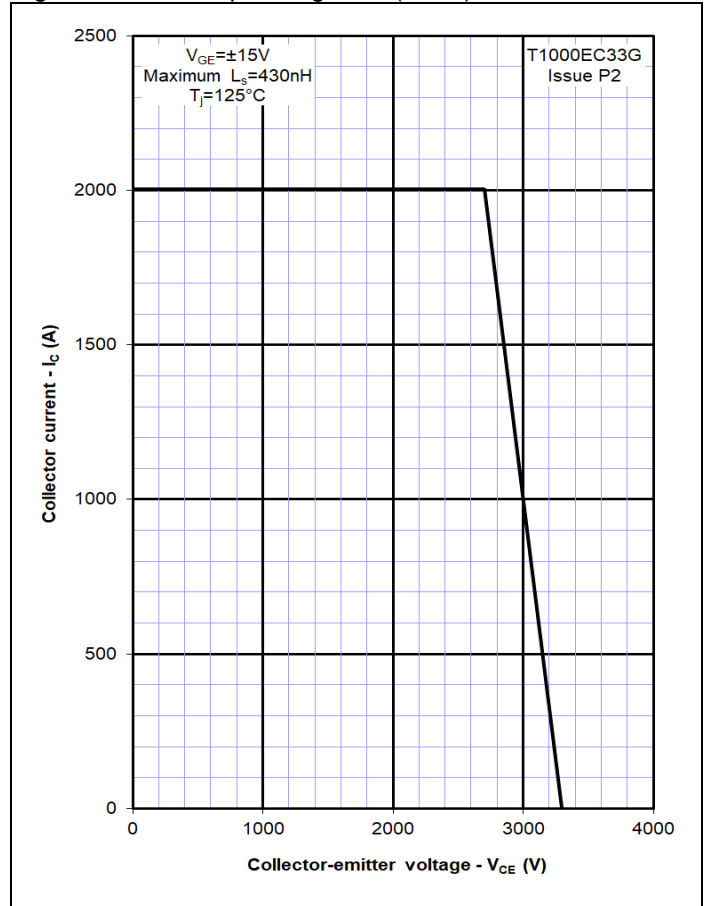


Figure 11 – Typical diode forward characteristics

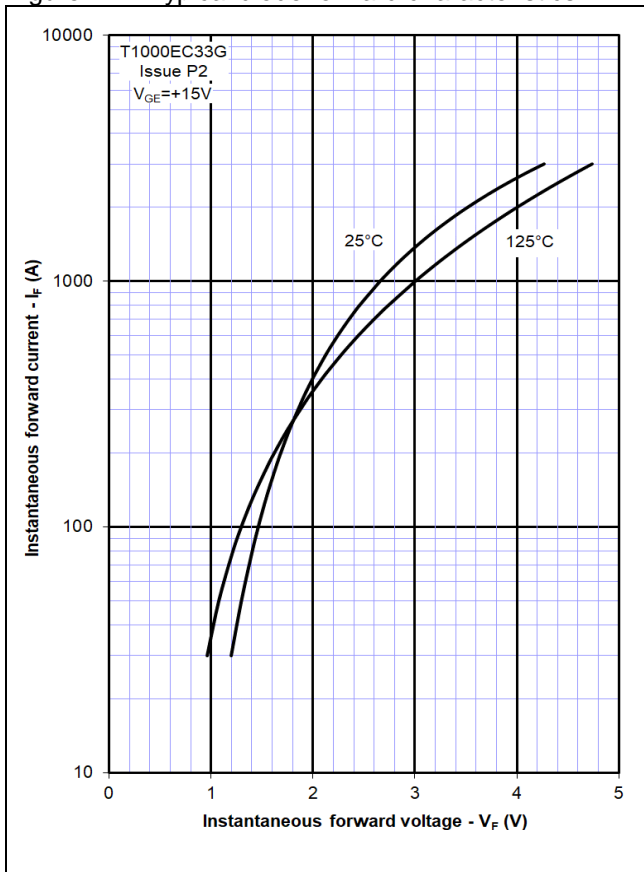


Figure 12 – Typical recovered charge

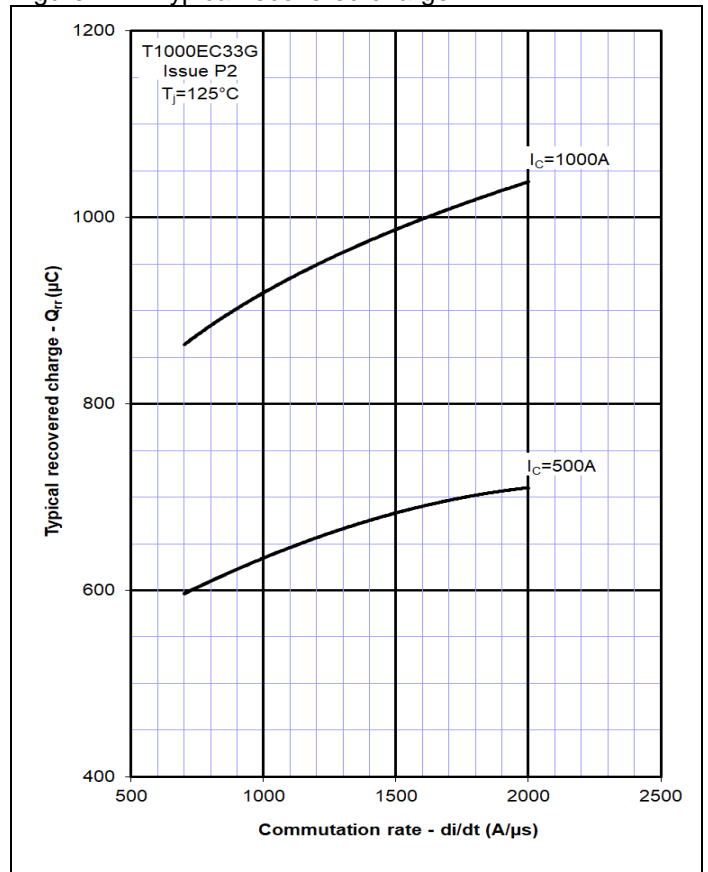


Figure 13 – Typical reverse recovery current

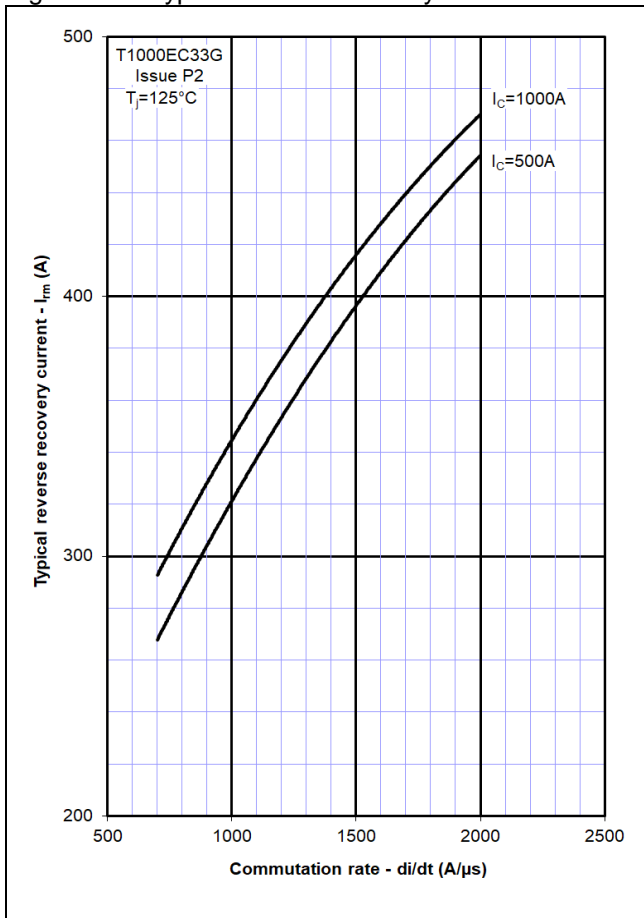


Figure 14 – Typical reverse recovery time

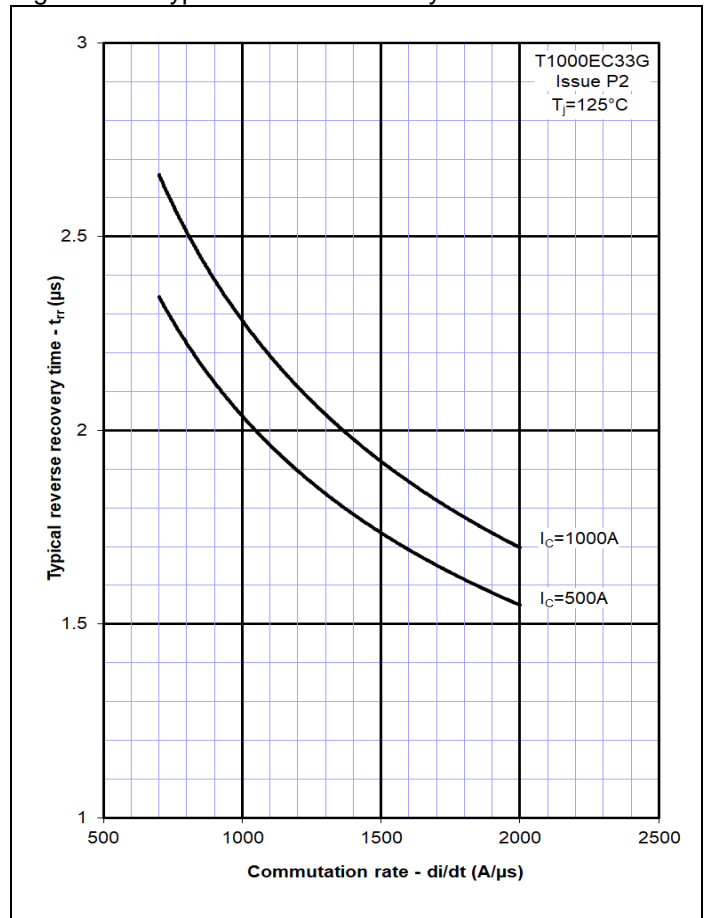


Figure 15 – Typical reverse recovery energy

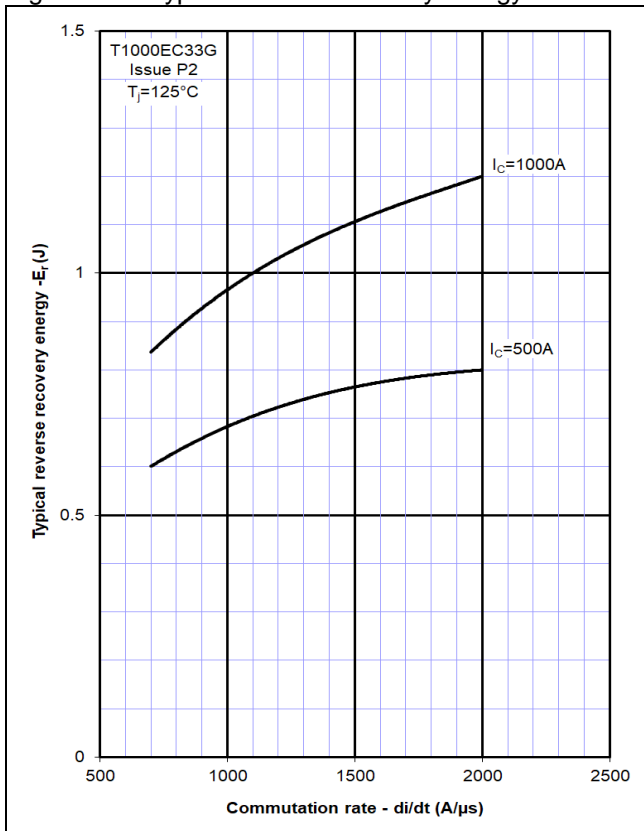


Figure 16 – Safe operating area (Diode)

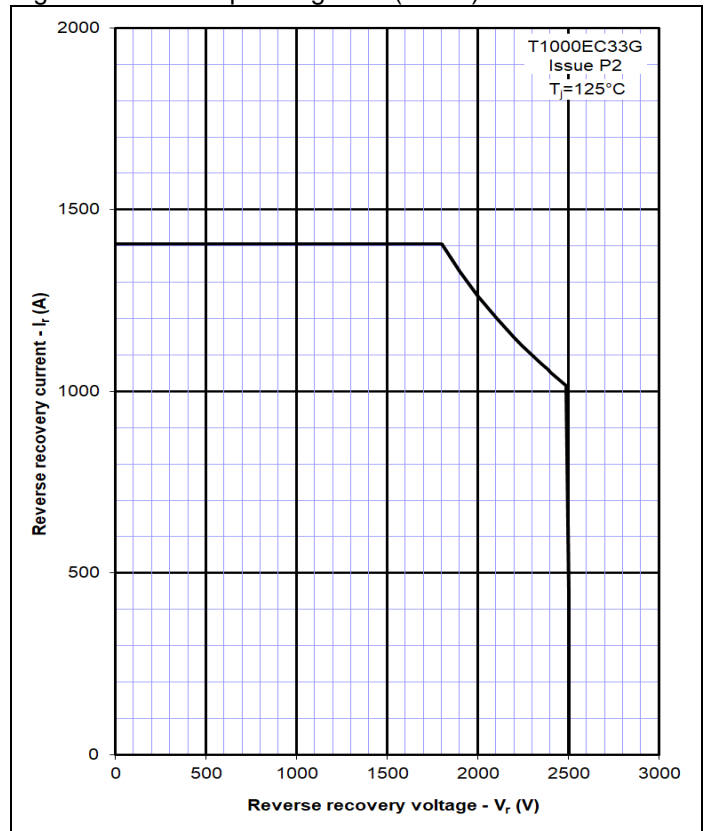


Figure 17 – Transient thermal impedance (IGBT)

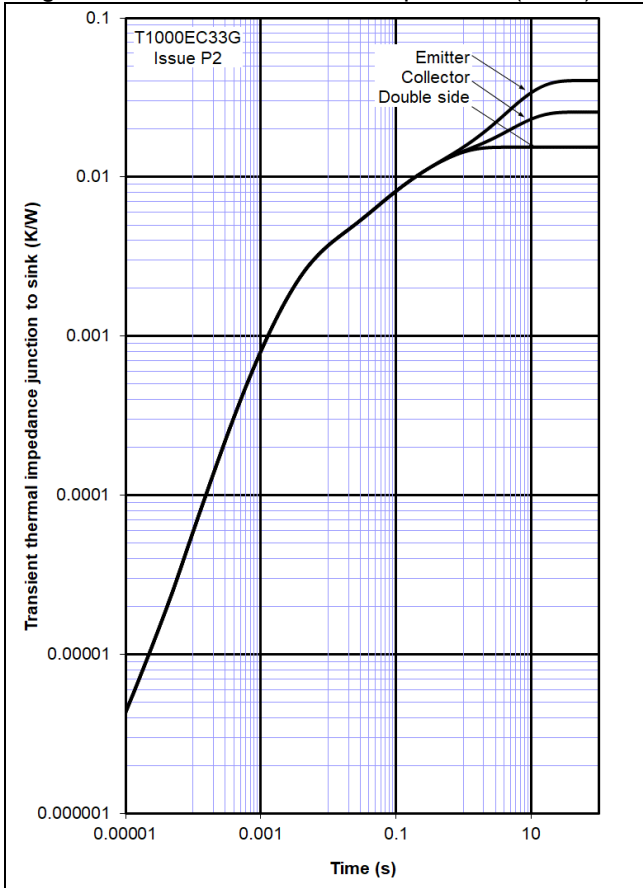
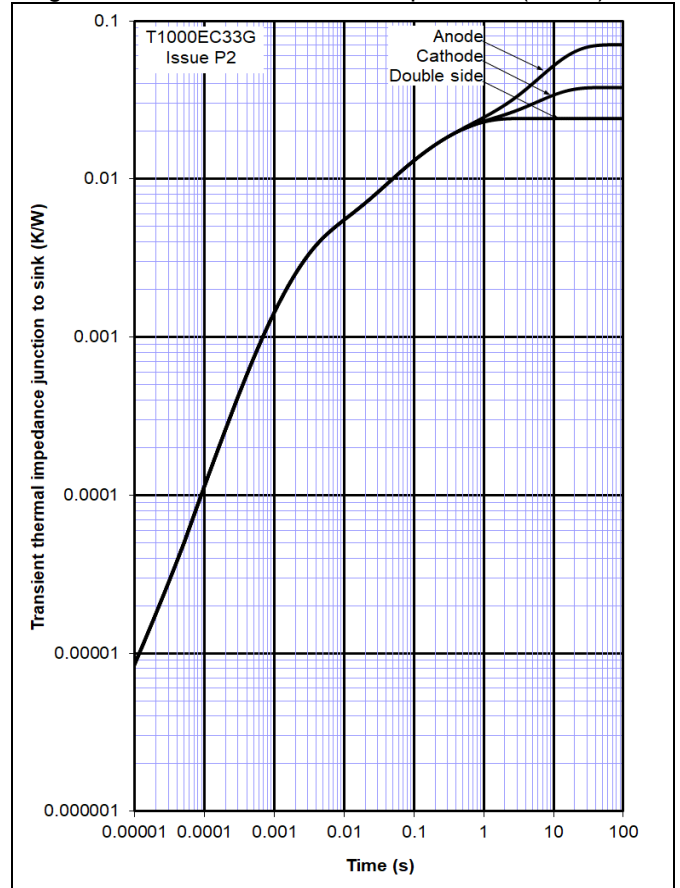
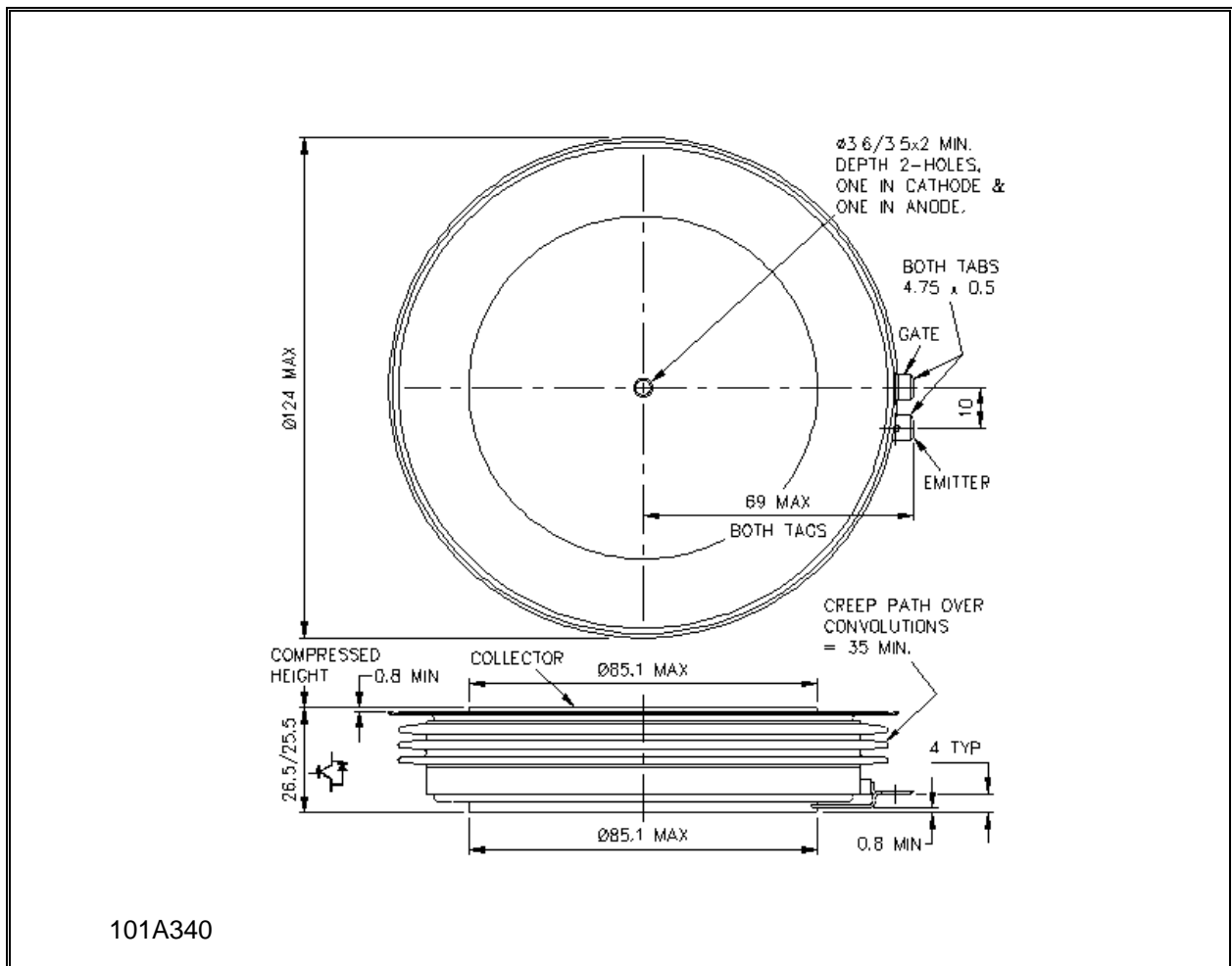


Figure 18 – Transient thermal impedance (Diode)



Outline Drawing & Ordering Information



ORDERING INFORMATION

(Please quote 10 digit code as below)

T1000	EC	33	G
Fixed type Code	Fixed Outline Code	Voltage Grade $V_{CES}/100$ 33	Fixed format code

 Typical order code: T1000EC33G ($V_{CES} = 3300V$)

IXYS Semiconductor GmbH
 Edisonstraße 15
 D-68623 Lampertheim
 Tel: +49 6206 503-0
 Fax: +49 6206 503-627
 E-mail: marcom@ixys.de



IXYS
 A Littelfuse Technology

IXYS UK Westcode Ltd
 Langley Park Way, Langley Park,
 Chippenham, Wiltshire, SN15 1GE.
 Tel: +44 (0)1249 444524
 E-mail: sales@ixysuk.com

IXYS Corporation
 1590 Buckeye Drive
 Milpitas CA 95035-7418
 Tel: +1 (408) 457 9000
 Fax: +1 (408) 496 0670
 E-mail: sales@ixys.net

www.littelfuse.com

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www.ixys.net

IXYS Long Beach
 IXYS Long Beach, Inc
 2500 Mira Mar Ave, Long Beach
 CA 90815
 Tel: +1 (562) 296 6584
 Fax: +1 (562) 296 6585
 E-mail: service@ixyslongbeach.com

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